Memory Module Specifications



R&D | OEM | ODM SSD & DDRAM

ST16D3N13S816G

SemiTank S8 16GB DDR3 1600 SO-DIMM

DESCRIPTION

This document describes DDR3 204 Pin SO-DIMM Non ECC, P/N: ST16D3N13S816G. This Memory Module based on Capacity 16GB, Frequency 1600 Mhz, Latency CL11, Data Transfer Bandwidth 12.800 MB/s. DDR3 204 Pin SO-DIMM Non ECC uses gold contact fingers and used for:

- * Laptop.
- * All in One Computer.
- * Industrial Computer.
 * Mini Computer.

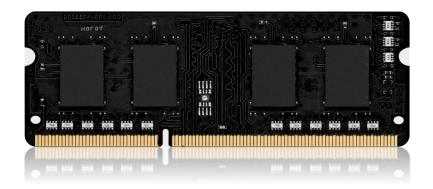
The electrical and mechanical specifications are as follows:

Feature

- Increased Fundamental Frequency, Faster Speeds.
- Unleashed Capacity, Stronger, Multitasking.
- Improved Structural Composition, Greater Efficiency.
- Reduced Working Voltage. Better Energy Efficiency.
- RoHS Compliant and Halogen-Free.

SPECIFICATIONS

Module type	DDR3 204 Pin SO-DIMM Non ECC
Product Dimensions	67.6*30*3.37 mm
Series	S8 Series
Frequency	1600 Mhz
Latency	CL11
Data Transfer Bandwidth	PC3 12800 12.800 MB/s
Capacity	16GB
	1.002
Voltage	1.35V
Voltage Operating Temperature	
-	1.35V
Operating Temperature	1.35V 0°C to +70°C



*Note:

- We reserve the right to modify product specifications without prior notice.
- Check "Product Compatibility Inquiry" before purchase for further info.